

SKM 500GA123D



SEMITRANS® 4

IGBT Modules

SKM 500GA123D

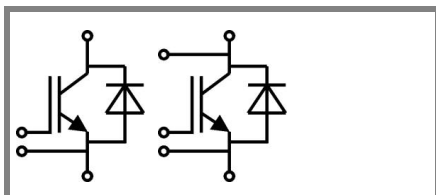
SKM 500GA123DS

Features

- MOS input (voltage controlled)
- N channel, homogeneous Si
- Low inductance case
- Very low tail current with low temperature dependence
- High short circuit capability, self limiting to $6 \times I_{Cnom}$
- Latch-up free
- Fast & soft CAL diodes
- Isolated copper baseplate using DBC Direct Copper Bonding Technology
- Large clearance (12 mm) and creepage distances (20 mm)

Typical Applications

- AC inverter drives
- UPS



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Absolute Maximum Ratings		$T_c = 25^\circ\text{C}$, unless otherwise specified			
Symbol	Conditions	Values		Units	
IGBT					
V_{CES}	$T_j = 25^\circ\text{C}$	1200		V	
I_C	$T_j = 150^\circ\text{C}$	$T_{case} = 25^\circ\text{C}$	500	A	
		$T_{case} = 80^\circ\text{C}$	420	A	
I_{CRM}	$I_{CRM} = 2 \times I_{Cnom}$	800		A	
V_{GES}		± 20		V	
t_{psc}	$V_{CC} = 600\text{ V}; V_{GE} \leq 20\text{ V}; T_j = 125^\circ\text{C}$ $V_{CES} < 1200\text{ V}$	10		μs	
Inverse Diode					
I_F	$T_j = 150^\circ\text{C}$	$T_{case} = 25^\circ\text{C}$	500	A	
		$T_{case} = 80^\circ\text{C}$	350	A	
I_{FRM}	$I_{FRM} = 2 \times I_{Fnom}$	800		A	
I_{FSM}	$t_p = 10\text{ ms}; \text{sin.}$	$T_j = 150^\circ\text{C}$	3600		A
Module					
$I_{t(RMS)}$		500		A	
T_{vj}		- 40 ... + 150		$^\circ\text{C}$	
T_{stg}		- 40 ... + 125		$^\circ\text{C}$	
V_{isol}	AC, 1 min.	2500		V	

Characteristics		$T_c = 25^\circ\text{C}$, unless otherwise specified					
Symbol	Conditions	min.	typ.	max.	Units		
IGBT							
$V_{GE(th)}$	$V_{GE} = V_{CE}, I_C = 16\text{ mA}$	4,5	5,5	6,5	V		
I_{CES}	$V_{GE} = 0\text{ V}, V_{CE} = V_{CES}$	$T_j = 25^\circ\text{C}$		0,1	0,3	mA	
V_{CE0}		$T_j = 25^\circ\text{C}$		1,4	1,6	V	
		$T_j = 125^\circ\text{C}$		1,6	1,8	V	
r_{CE}	$V_{GE} = 15\text{ V}$	$T_j = 25^\circ\text{C}$		2,75	3,5	$\text{m}\Omega$	
		$T_j = 125^\circ\text{C}$		3,75	4,75	$\text{m}\Omega$	
$V_{CE(sat)}$	$I_{Cnom} = 400\text{ A}, V_{GE} = 15\text{ V}$	$T_j = ^\circ\text{C}_{chiplev.}$		2,5	3	V	
C_{ies}	$V_{CE} = 25, V_{GE} = 0\text{ V}$	$f = 1\text{ MHz}$		26	40	nF	
C_{oes}				4	5,2	nF	
C_{res}				2	2,6	nF	
R_{Gint}	$T_j = ^\circ\text{C}$			1,25		Ω	
$t_{d(on)}$	$R_{Gon} = 3,3\ \Omega$	$V_{CC} = 600\text{ V}$ $I_{Cnom} = 400\text{ A}$			250	600	ns
t_r					170	340	ns
E_{on}	$R_{Goff} = 3,3\ \Omega$	$T_j = 125^\circ\text{C}$ $V_{GE} = \pm 15\text{ V}$			45		mJ
$t_{d(off)}$					900	1100	ns
t_f					100	125	ns
E_{off}						mJ	
$R_{th(j-c)}$	per IGBT			0,041		K/W	



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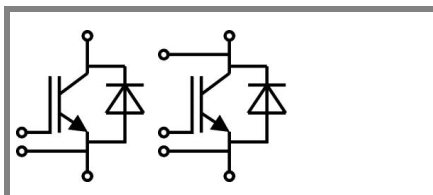
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Characteristics

Symbol	Conditions	min.	typ.	max.	Units
Inverse Diode					
$V_F = V_{EC}$	$I_{Fnom} = 400 \text{ A}; V_{GE} = 0 \text{ V}$	$T_j = 25 \text{ }^\circ\text{C}_{\text{chiplev.}}$	2	2,5	V
		$T_j = 125 \text{ }^\circ\text{C}_{\text{chiplev.}}$	1,8		V
V_{F0}		$T_j = 25 \text{ }^\circ\text{C}$	1,1	1,2	V
		$T_j = 125 \text{ }^\circ\text{C}$			V
r_F		$T_j = 25 \text{ }^\circ\text{C}$	2,3	3,3	mΩ
		$T_j = 125 \text{ }^\circ\text{C}$			mΩ
I_{RRM}	$I_{Fnom} = 400 \text{ A}$	$T_j = 25 \text{ }^\circ\text{C}$	90		A
Q_{rr}	$di/dt = 2000 \text{ A}/\mu\text{s}$		15		μC
E_{rr}	$V_{GE} = 0 \text{ V}; V_{CC} = 600 \text{ V}$				mJ
$R_{th(j-c)D}$	per diode			0,09	K/W
Freewheeling Diode					
$V_F = V_{EC}$	$I_{Fnom} = \text{A}; V_{GE} = \text{V}$	$T_j = \text{ }^\circ\text{C}_{\text{chiplev.}}$			V
V_{F0}		$T_j = 25 \text{ }^\circ\text{C}$			V
		$T_j = 125 \text{ }^\circ\text{C}$			V
r_F		$T_j = 25 \text{ }^\circ\text{C}$			V
		$T_j = 125 \text{ }^\circ\text{C}$			V
I_{RRM}	$I_{Fnom} = \text{A}$	$T_j = \text{ }^\circ\text{C}$			A
Q_{rr}					μC
E_{rr}	$V_{GE} = 0 \text{ V}; V_{CC} = 600 \text{ V}$				mJ
	per diode				K/W
Module					
L_{CE}			15	20	nH
R_{CC+EE}	res., terminal-chip	$T_{case} = 25 \text{ }^\circ\text{C}$	0,18		mΩ
		$T_{case} = 125 \text{ }^\circ\text{C}$	0,22		mΩ
$R_{th(c-s)}$	per module			0,038	K/W
M_s	to heat sink M6		3	5	Nm
M_t	to terminals M6 (M4)		2,5 (1,1)	5 (2)	Nm
w				330	g

This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

This technical information specifies semiconductor devices but promises no characteristics. No warranty or guarantee expressed or implied is made regarding delivery, performance or suitability.

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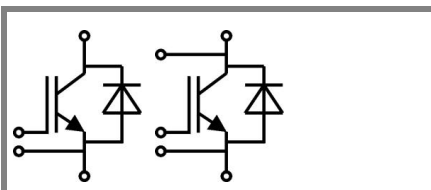
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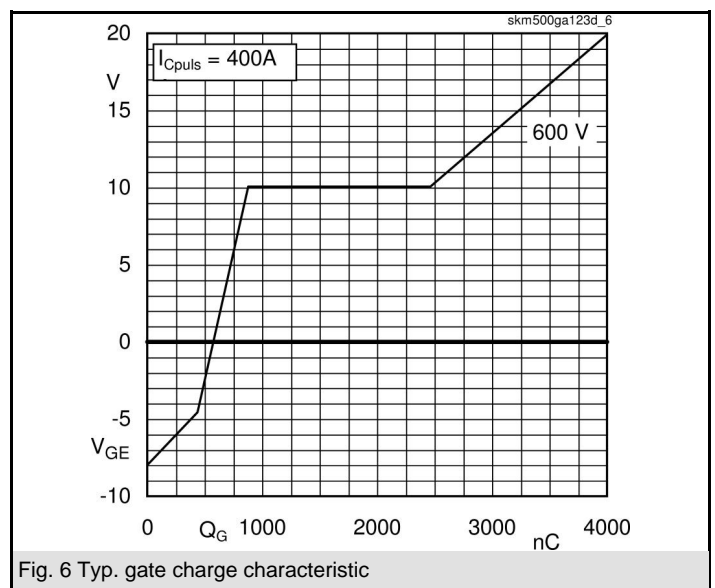
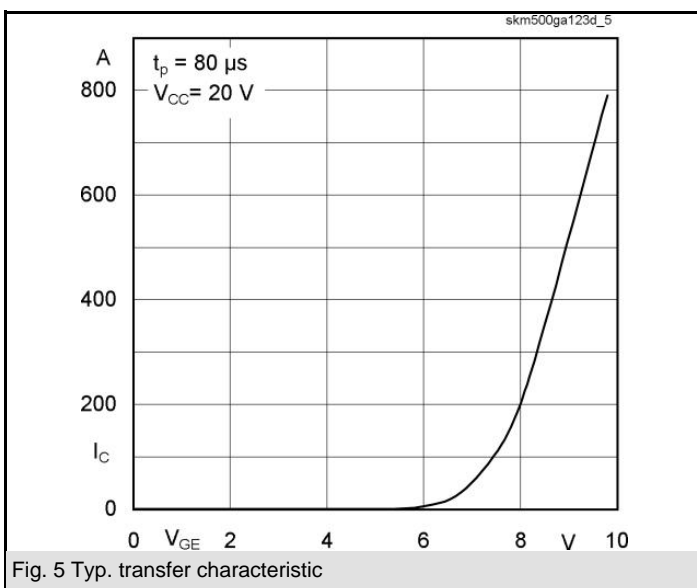
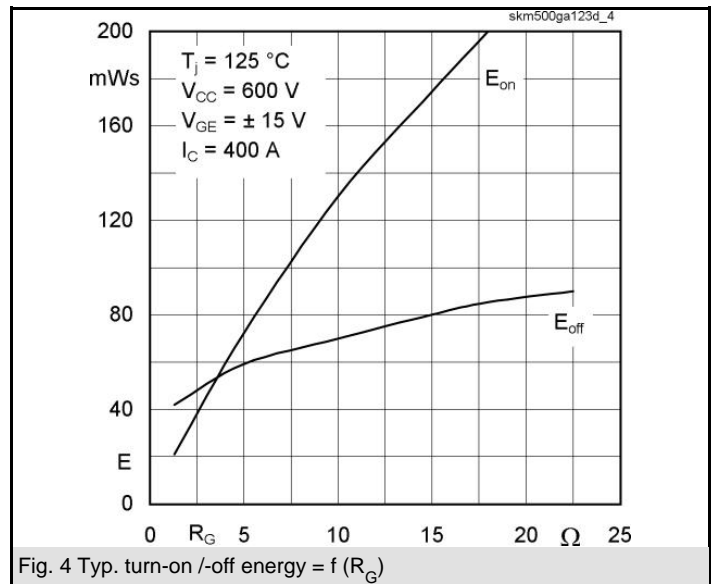
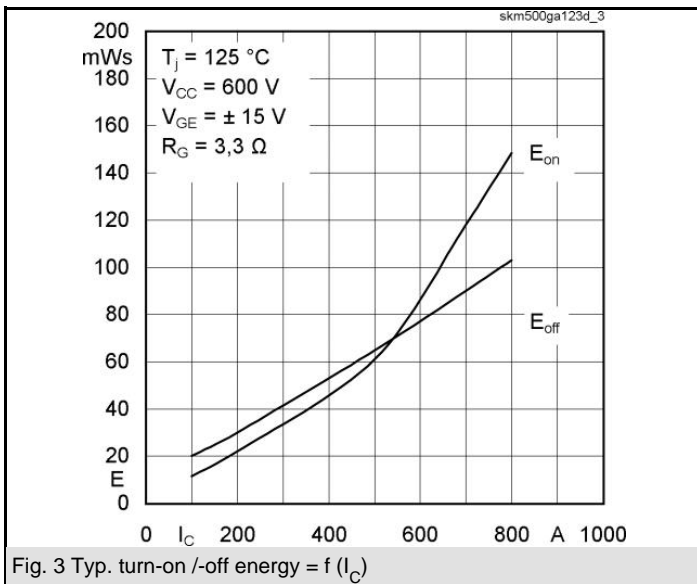
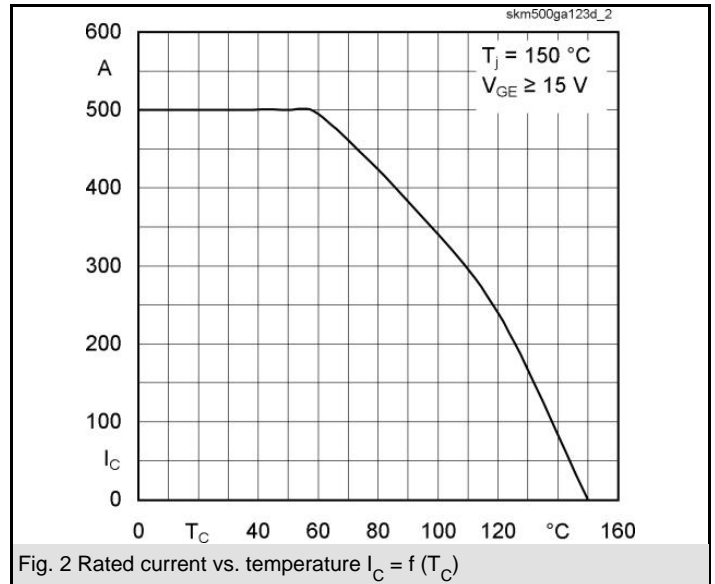
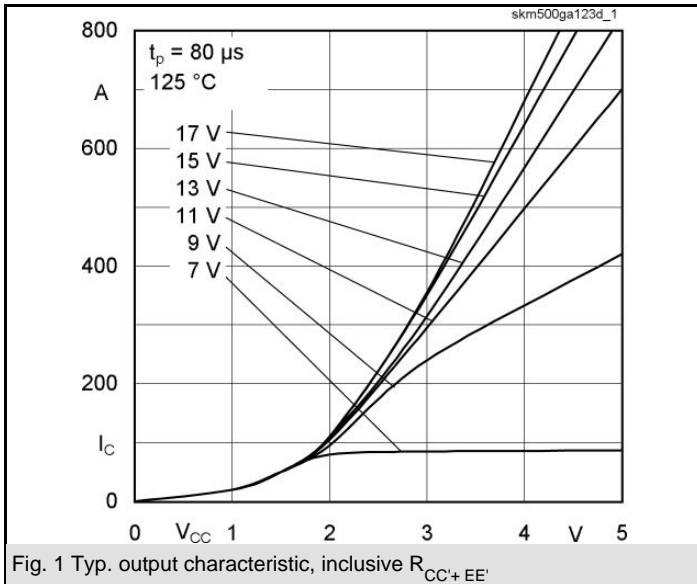
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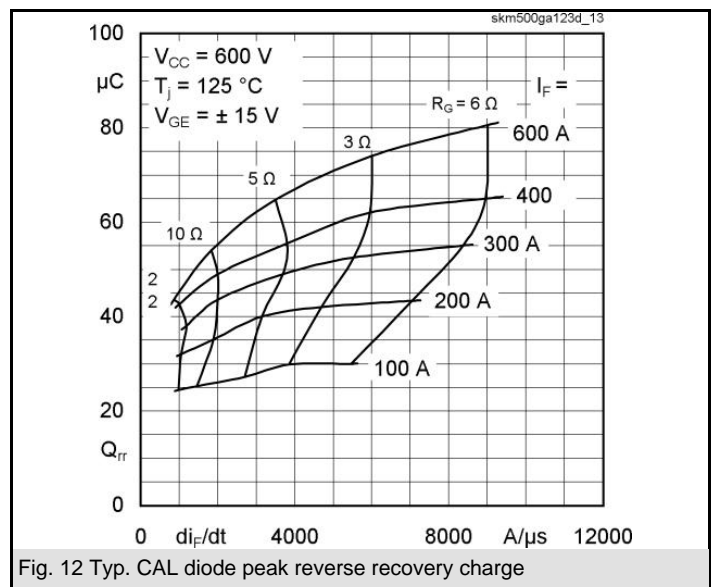
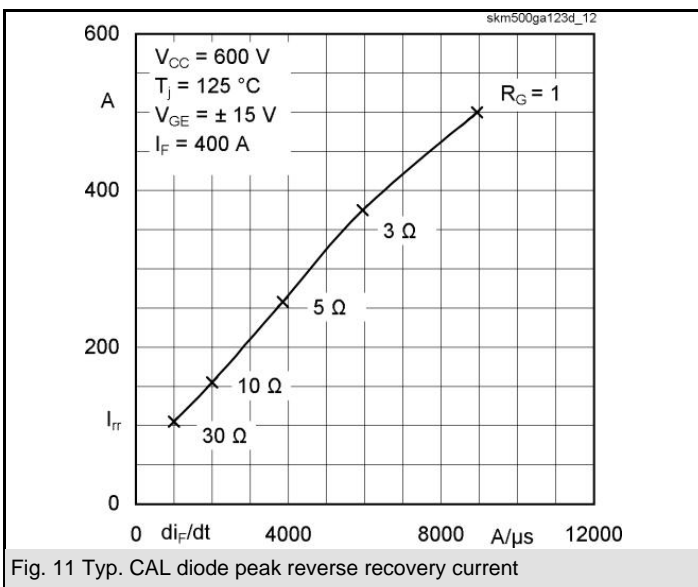
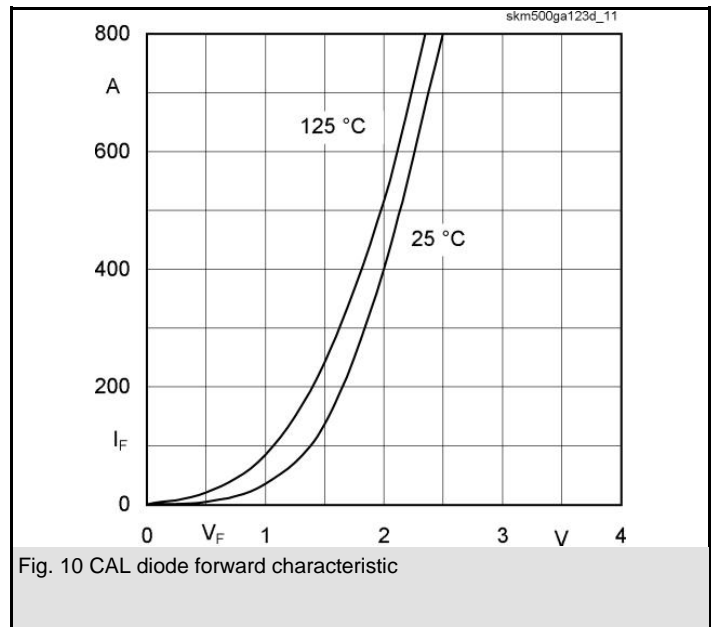
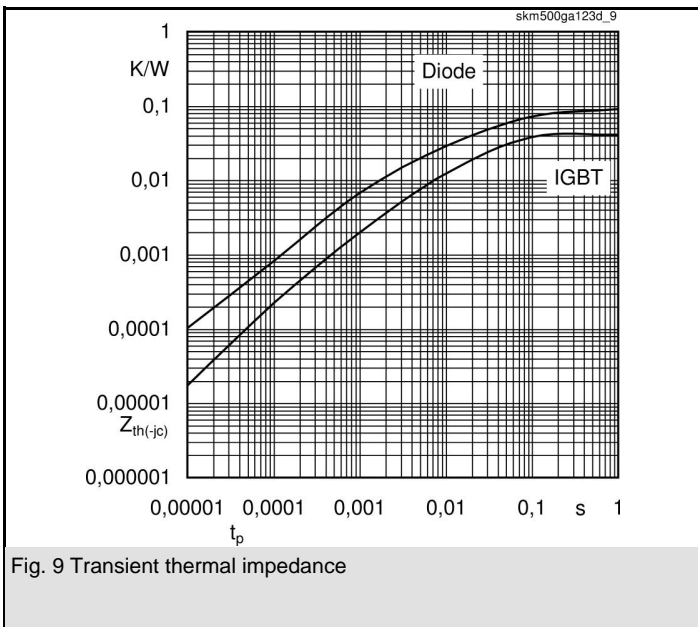
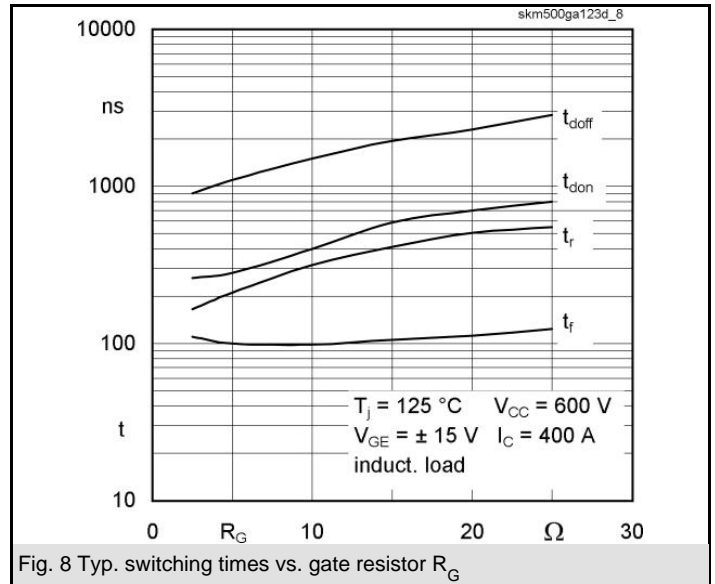
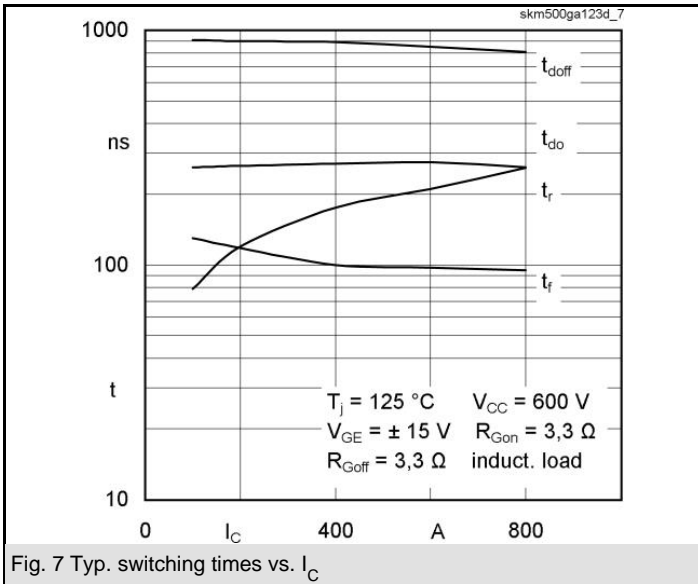


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Z_{th}		Conditions	Values	Units
Symbol				
$Z_{th(j-c)I}$				
$R_{\theta j-c}$	$i = 1$		29	mk/W
$R_{\theta j-c}$	$i = 2$		10	mk/W
$R_{\theta j-c}$	$i = 3$		1,8	mk/W
$R_{\theta j-c}$	$i = 4$		0,2	mk/W
$\tau_{th(j-c)I}$	$i = 1$		0,04	s
$\tau_{th(j-c)I}$	$i = 2$		0,0189	s
$\tau_{th(j-c)I}$	$i = 3$		0,0017	s
$\tau_{th(j-c)I}$	$i = 4$		0,001	s
Symbol				
$Z_{th(j-c)D}$				
$R_{\theta j-c}$	$i = 1$		60	mk/W
$R_{\theta j-c}$	$i = 2$		23	mk/W
$R_{\theta j-c}$	$i = 3$		6,2	mk/W
$R_{\theta j-c}$	$i = 4$		0,8	mk/W
$\tau_{th(j-c)D}$	$i = 1$		0,0366	s
$\tau_{th(j-c)D}$	$i = 2$		0,042	s
$\tau_{th(j-c)D}$	$i = 3$		0,0009	s
$\tau_{th(j-c)D}$	$i = 4$		0,002	s



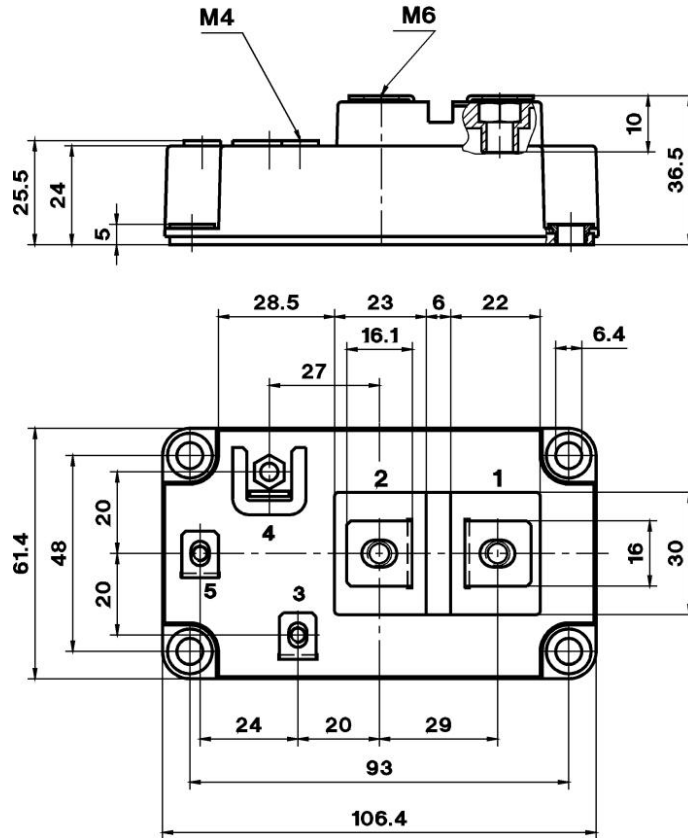


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UL Recognized

CASED59

File 63 532



Case D 60

